

ABSTRACT

A method of manufacturing a processed product includes: a preparing step of preparing a workpiece (1) including at least a lead frame having a groove portion (5) formed in advance along a position to be cut; a surface layer removing step of, before cutting the workpiece (1), partially removing a surface layer portion (3c) forming the groove portion (5) in the workpiece (1); and a plating step of, before cutting the workpiece (1), performing a plating treatment on the workpiece (1) from which the surface layer portion (3c) is partially removed. In a state before the surface layer removing step is performed, the surface layer portion (3c) includes: a cut region (3m) to be removed by cutting the workpiece (1); and an uncut region (3n) located between the cut region (3m) and an opening end (5c) of the groove portion (5). In the surface layer removing step, at least a part of the uncut region (3n) is removed. This provides a method of manufacturing a processed product, by which higher connection reliability can be achieved.